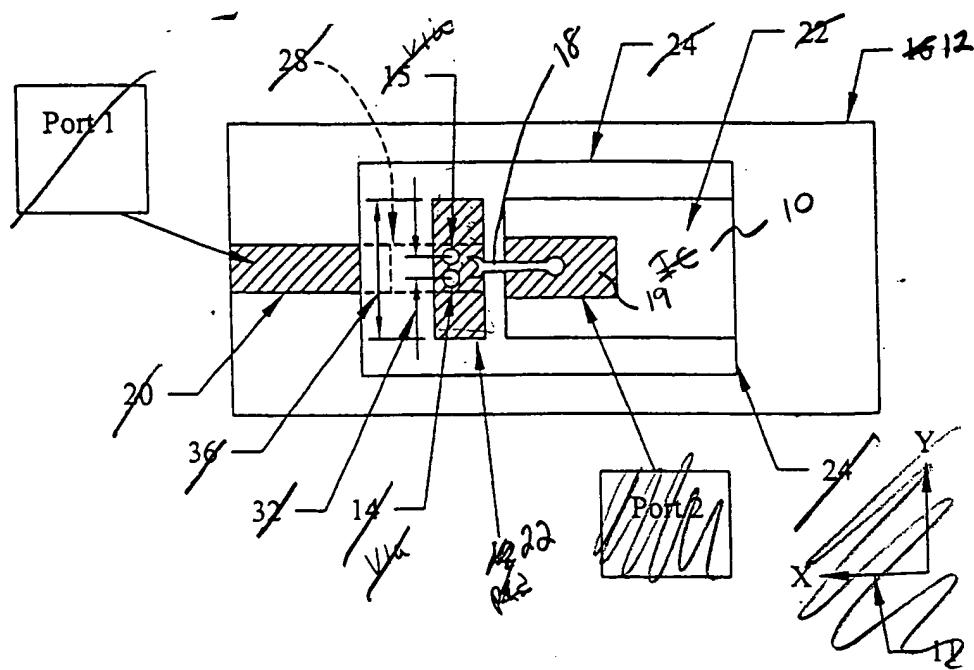
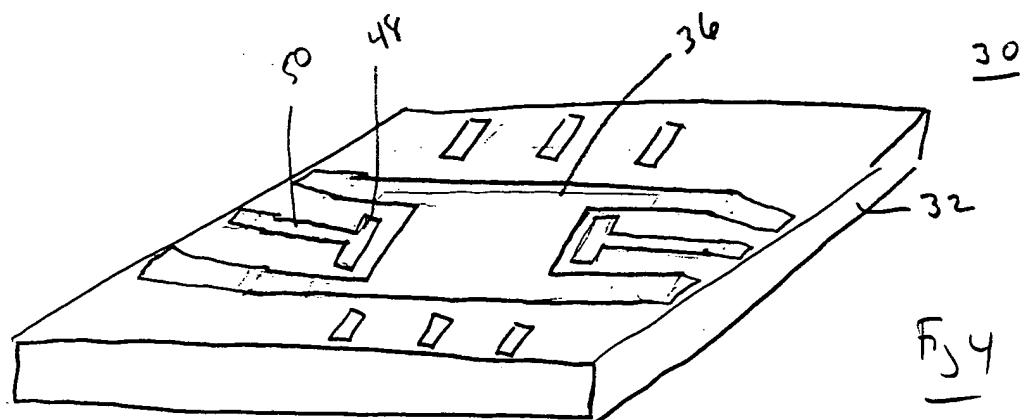
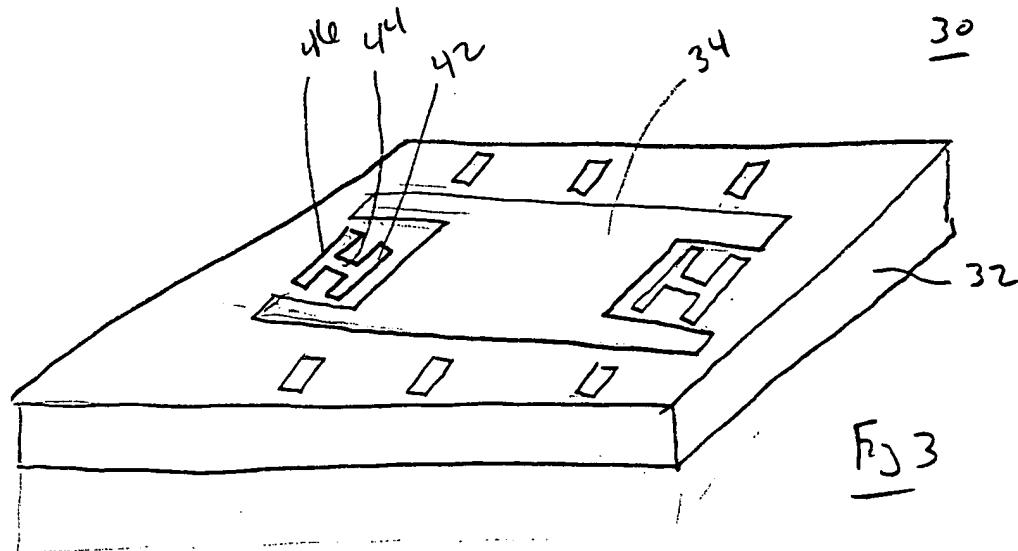


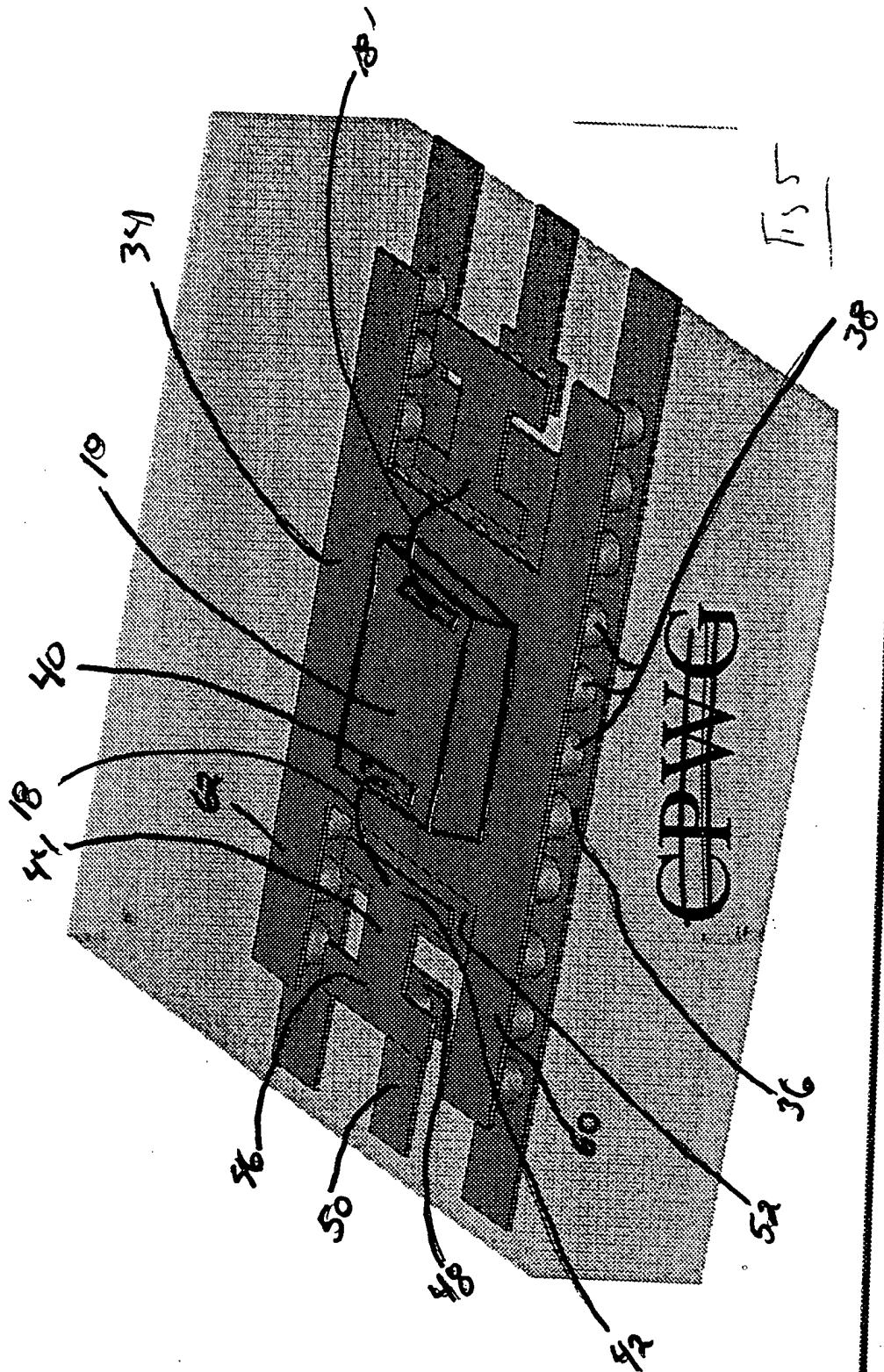
Fig. 1

2 of 10

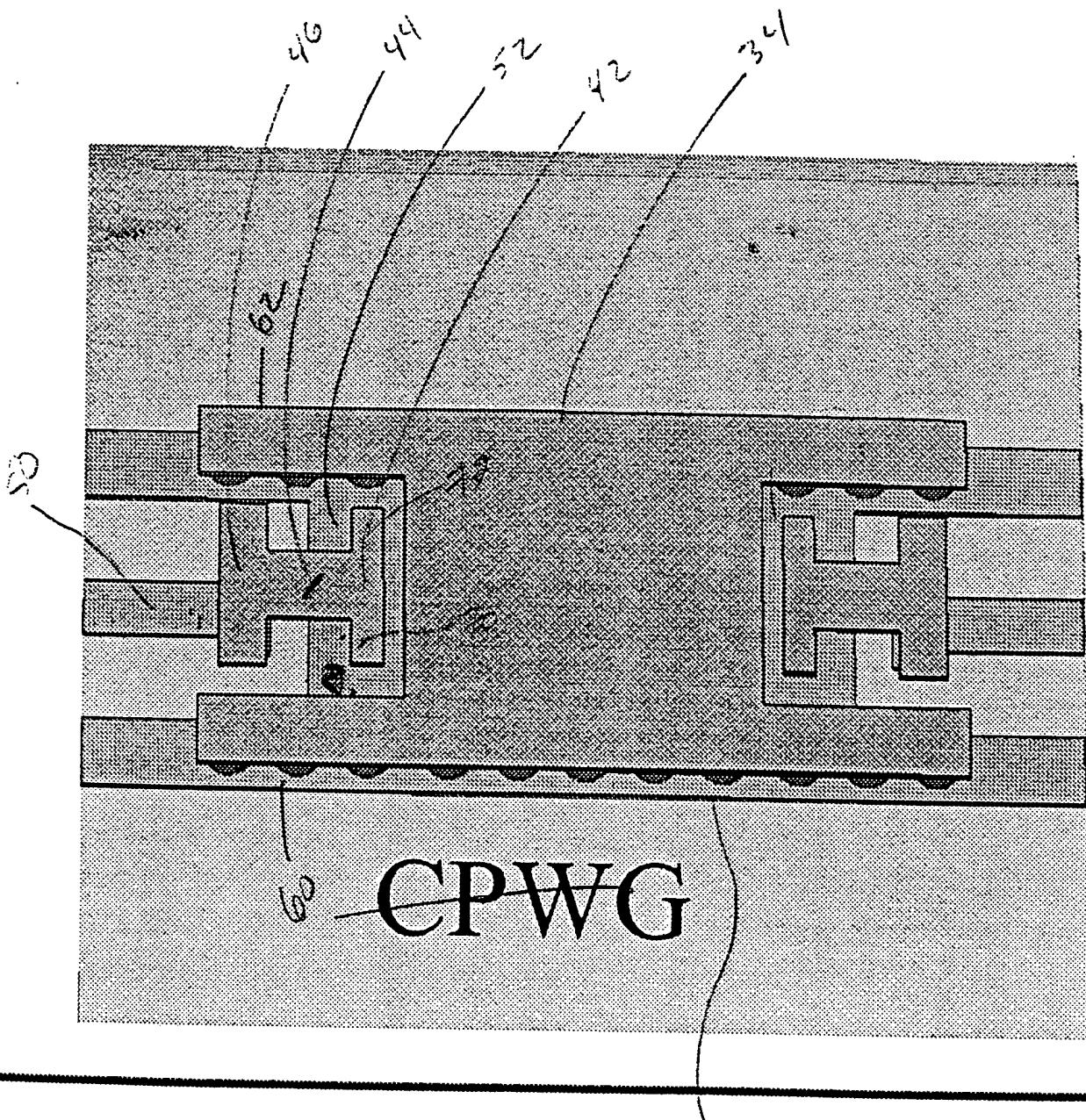


F₂
(prior art)





SOF¹⁰



3

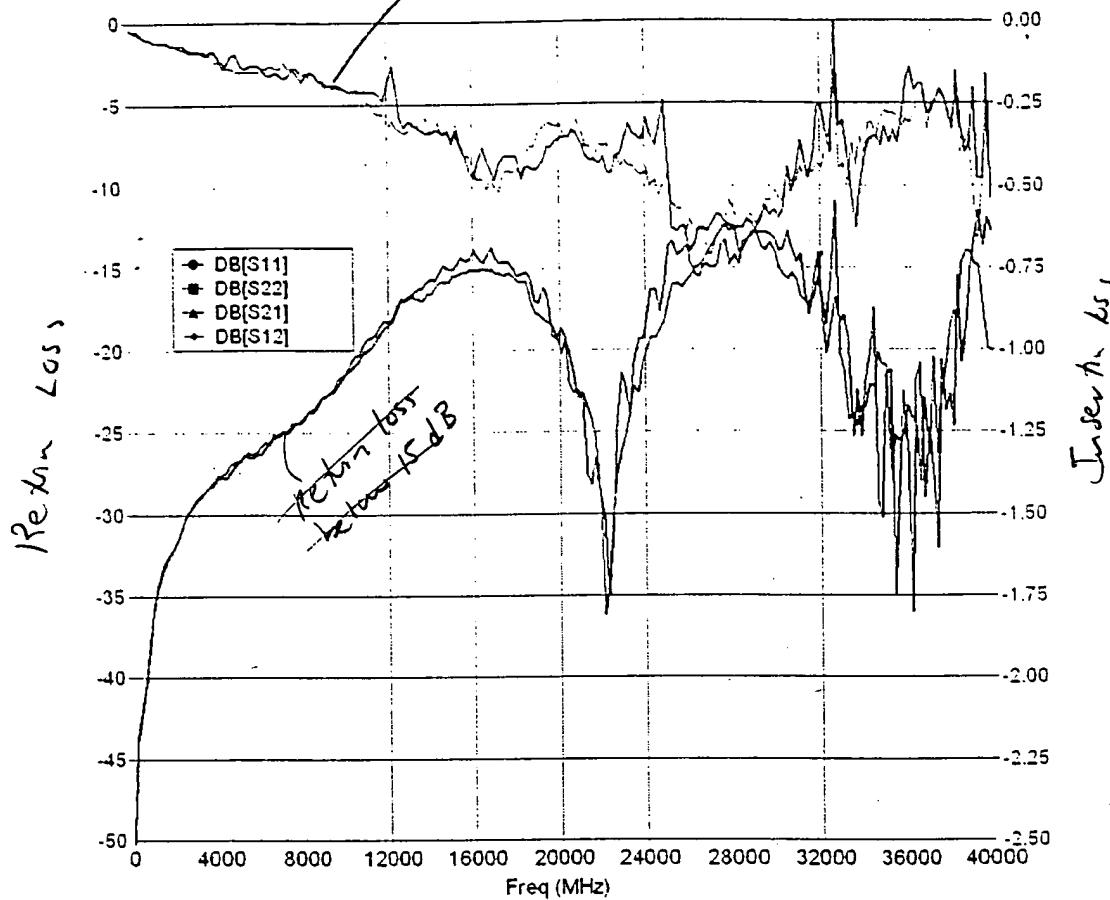
۲۶

FJ 6

~~Comp~~

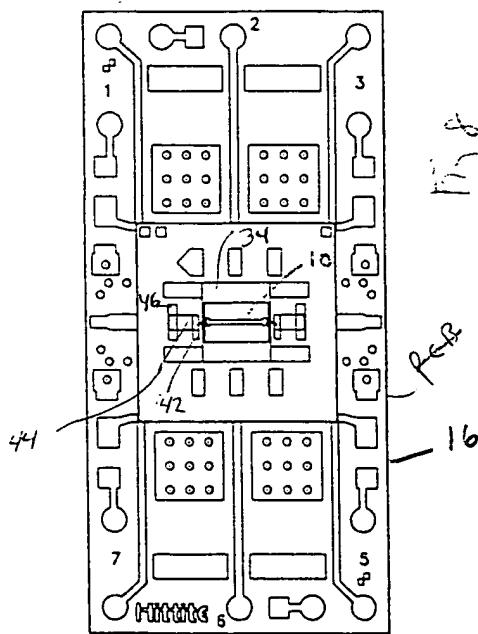
6 of 10

6. 50 Ohm line on top of carrier and on top of probable eval board (trimmed matching and single bond wire):



Inset h. b.s.

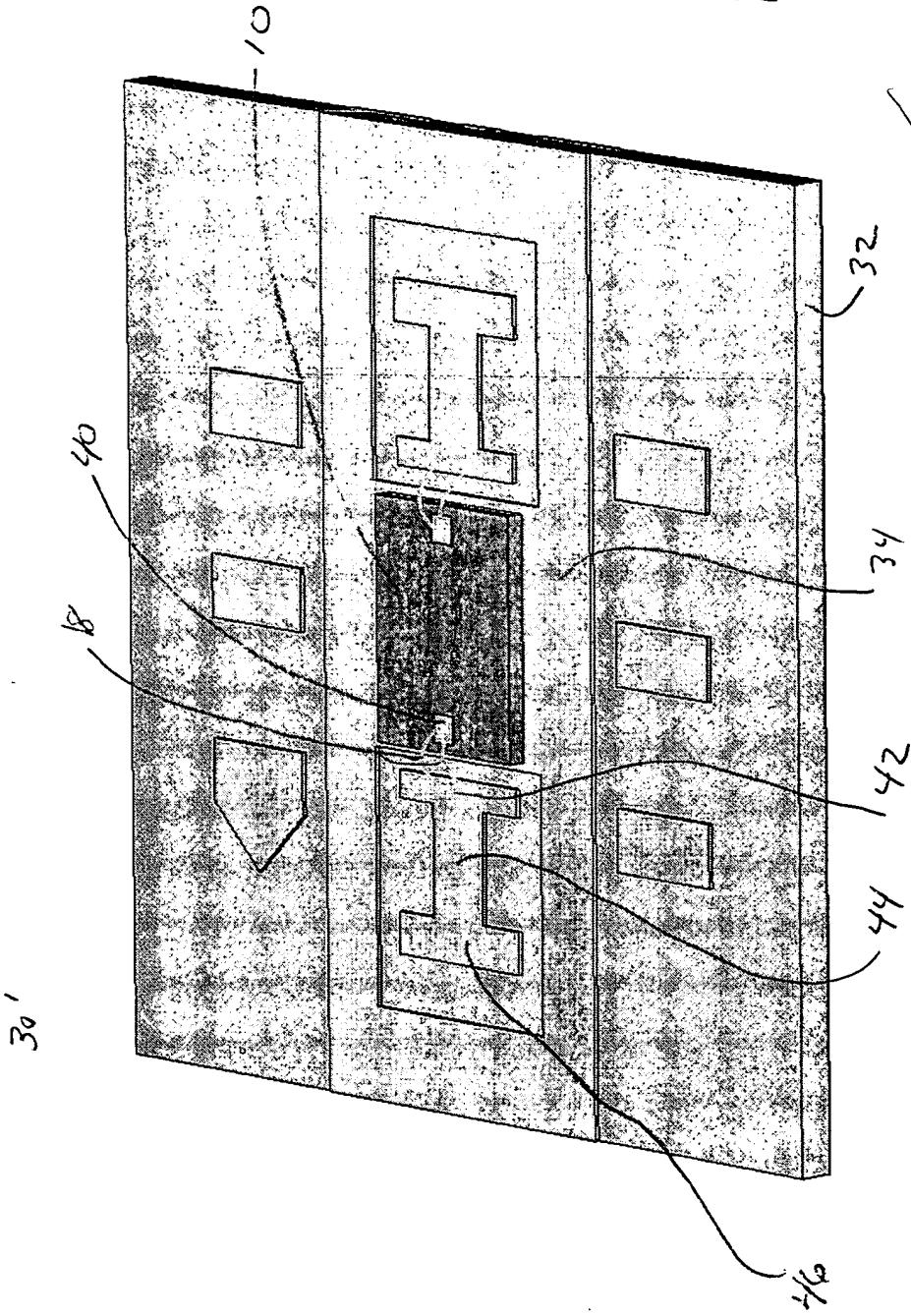
FJ 7



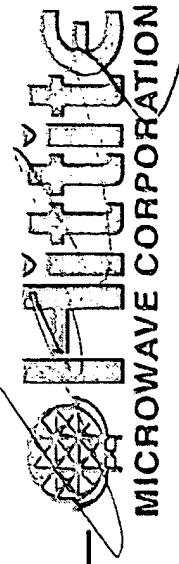
—1/09/2004

Screenshot

Applicant: Ekrem Oran
Title: RF PACKAGE
Docket No.: HIT-131J
Attorney: Kirk Teska, Reg. No. 36,291
Page 7 of 10



70F10



Company Proprietary

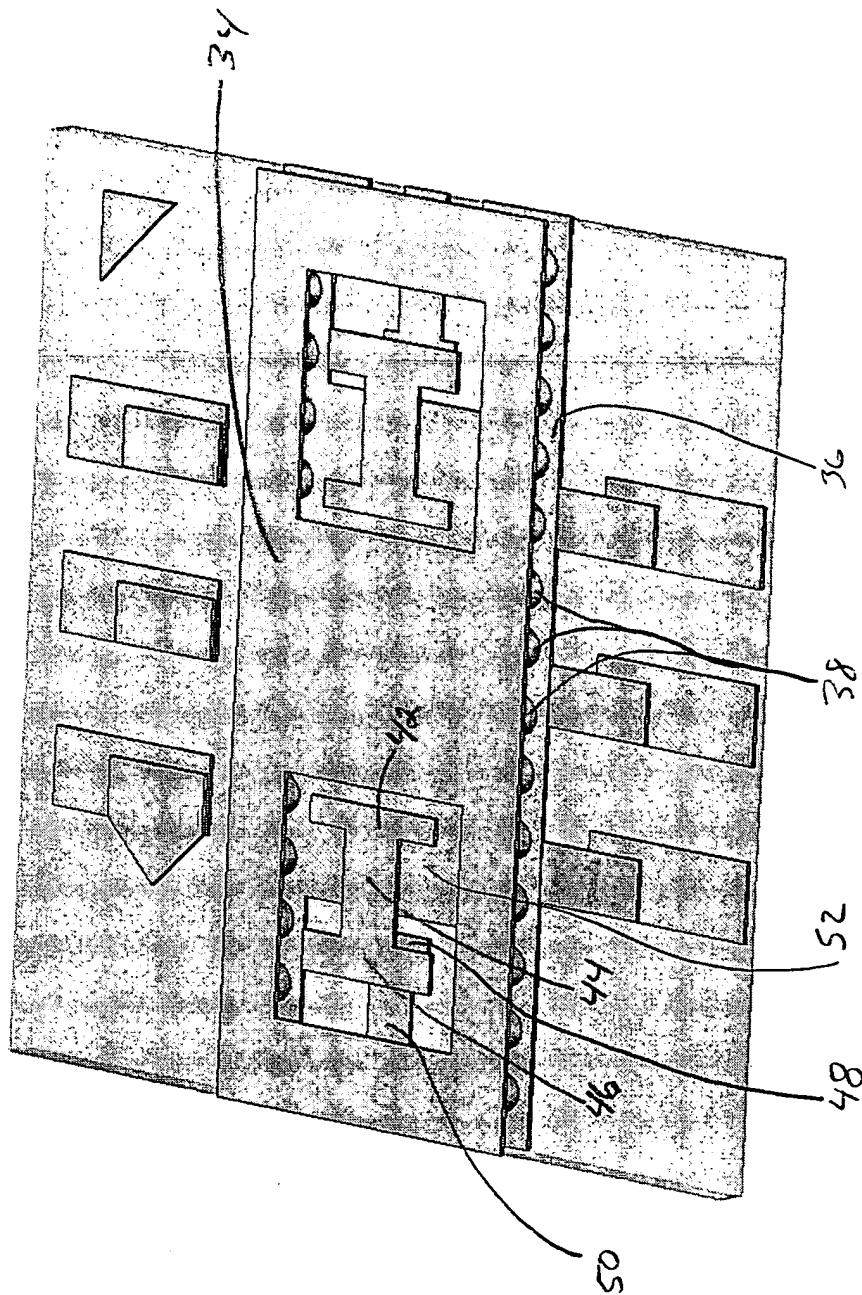
1/09/2004

Screenshot

Applicant: Ekrem Oran
Title: RF PACKAGE
Docket No.: HIT-131J
Attorney: Kirk Teska, Reg. No. 36,291
Page 8 of 10

8 of 10

F5 10



Company-Proprietary

7

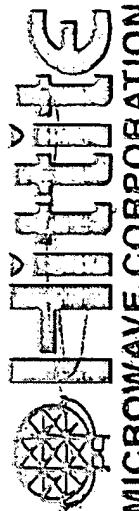
1/09/2004

Screenshot

Applicant: Ekrem Oran
Title: RF PACKAGE
Docket No.: HIT-131J
Attorney: Kirk Teska, Reg. No. 36,291
Page 9 of 10

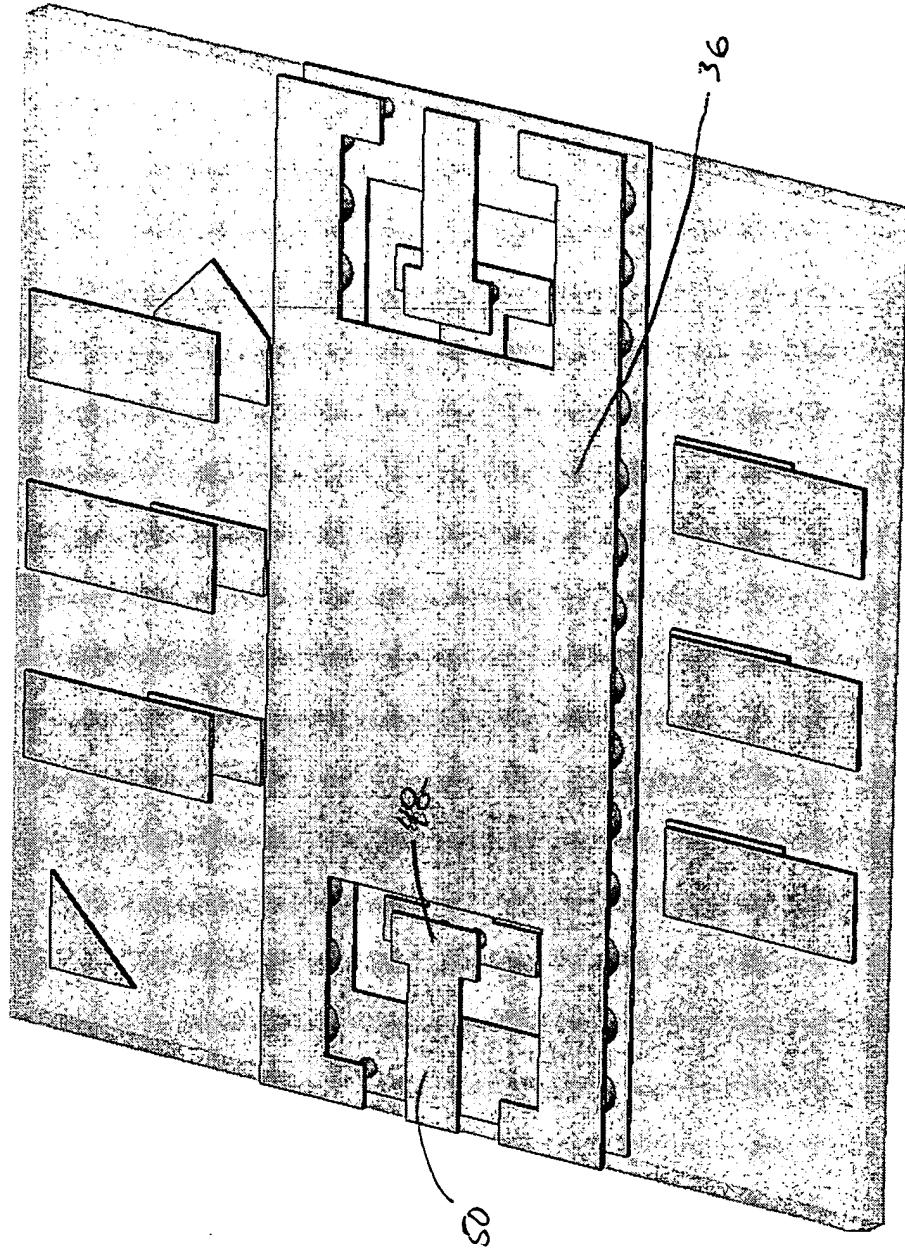
9/10

FJ 11



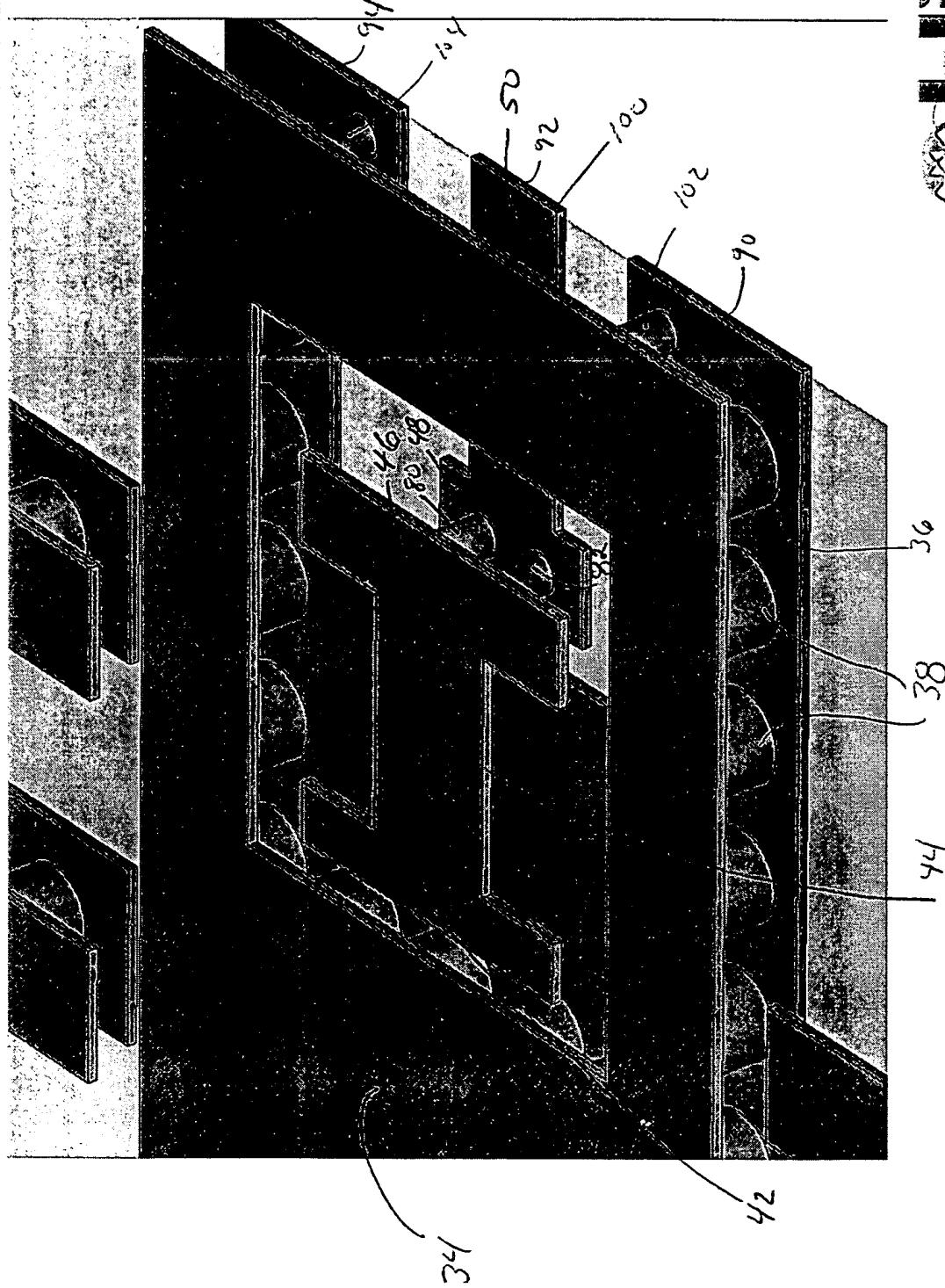
Company Proprietary

96



1/09/2004

Screenshot



Company Proprietary